

EPO-TEK[®] TJ2139-LH Technical Data Sheet For Reference Only Low Halogen Thermally Conductive Epoxy

Recommended Cure: 150°C / 1 Hour

Date:November 2019Rev:IXNo. of Components:TwoMix Ratio by Weight:100 : 5Specific Gravity:Part A: 1.54Pot Life:2.5 DaysShelf Life- Bulk:One year at -40°C

NOTES:

• Container(s) should be kept closed when not in use.

• Filled systems should be stirred thoroughly before mixing and prior to use.

• Performance properties (rheology, conductivity, others) of the product may vary from those stated on the data sheet when bi-pak/syringe packaging or post-processing of any kind is performed. Epoxy's warranties shall not apply to any products that have been reprocessed or repackaged from Epoxy's delivered status/container into any other containers of any kind, including but not limited to syringes, bi-paks, cartridges, pouches, tubes, capsules, films or other packages.

Product Description: EPO-TEK® TJ2139-LH is a two component, electrically insulating epoxy adhesive designed to meet low halogen standards.

Typical Properties: Cure condition: 150°C / 1 Hour Different batches, conditions & applications yield differing results.

Data below is not guaranteed. To be used as a guide only, not as a specification. * denotes test on lot acceptance basis

PHYSICAL PROPERTIES:		
* Color (before cure):	Part A: Ivory	Part B: Amber
* Consistency: Smooth slightly thixotropic paste		
* Viscosity (23°C) @ 10 rpm:	22,000-34,00	0 cPs
Thixotropic Index:	1	8
* Glass Transition Temp:	≥ 1(0 °C (Dynamic Cure: 20-200°C/ISO 25 Min; Ramp -10-200°C @20°C/Min)
Coefficient of Thermal Expansion (CTE):		
Below Tg:	4	5 x 10 ⁻⁶ in/in°C
Above Tg:	1:	57 x 10 ⁻⁶ in/in°C
Shore D Hardness:	8	5
Lap Shear @ 23°C:	> 2,00	10 psi
Die Shear @ 23°C:	≥ 2	20 Kg 7,112 psi
Degradation Temp:	4	9 °C
Weight Loss:		
@ 200°C:	< 0.0	5 %
@ 250°C:	0.1	9 %
@ 300°C:	0.4	3 %
Suggested Operating Temperature:	< 3	i0 °C (Intermittent)
Storage Modulus:	610,4	8 psi
Ion Content:	Cl ⁻ : 32 pp	m Na ⁺ : 30 ppm
	NH4+: 134 pp	m K⁺: 10 ppm
* Particle Size:	≤	20 microns
ELECTRICAL AND THERMAL PROPERTIES:		
Thermal Conductivity:		5 W/mK
Volume Resistivity @ 23°C	> 9 57 v 10	¹³ Ohm-cm
Dielectric Constant (1KHz):	= 3.37 X IC	опш-оп Б
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EPO-TEK® TJ2139-LH Advantages & Suggested Application Notes:

- Designed for high throughput dispensed die attach applications
- Offers long pot life (2.5 days)
- Meets international low halogen standards
- Applications:
 - o ASIC die attach in acoustic microphones for MEMS devices in mobile applications
 - o Die attach in medical grade hearing aids
 - Packaging and encapsulation in watch manufacturing